



BOARD CHARACTERISTICS

Copper Layer Count:	2	Board Thickness:	1.6000 mm
Board overall dimensions:	77.7975 mm x 77.7950 mm	Min hole diameter:	0.3000 mm
Min track/spacing:	0.0000 mm / 0.0000 mm	Impedance Control:	No
Copper Finish:	None	Plated Board Edge:	No
Castellated pads:	No		
Edge card connectors:	No		